

## ABSTRACT

Provided is a method of manufacturing a lead frame including a lead frame main body and a plating film on a surface thereof. The manufacturing method includes a plating step of performing plating treatment to dispose a first electrode connected to a polarity inversion power source so as to face a first main face of a lead frame main body and to dispose a second electrode connected to a pulse power source so as to face a second main face opposite to the first main face and forming the plating film on the first main face, the second main face, and a side face of the lead frame main body.

No Suitable figure